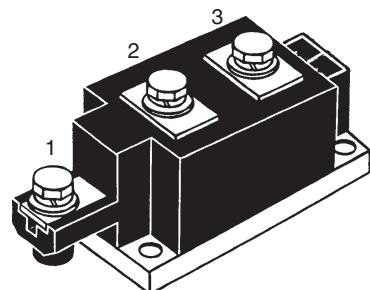
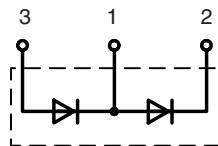


# High Power Diode Modules

**I<sub>FRMS</sub>** = 2x520 A  
**I<sub>FAVM</sub>** = 2x310 A  
**V<sub>RRM</sub>** = 1200-2200 V

V <sub>RSM</sub> V <sub>DSM</sub> V	V <sub>RRM</sub> V <sub>DRM</sub> V	Type
1300	1200	MDD 312-12N1
1500	1400	MDD 312-14N1
1700	1600	MDD 312-16N1
1900	1800	MDD 312-18N1
2100	2000	MDD 312-20N1
2300	2200	MDD 312-22N1



Symbol	Conditions	Maximum Ratings		
I <sub>FRMS</sub>	T <sub>VJ</sub> = T <sub>VJM</sub>	520	A	
I <sub>FAVM</sub>	T <sub>C</sub> = 100°C; 180° sine	310	A	
I <sub>FSM</sub>	T <sub>VJ</sub> = 45°C; V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	10500	A
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	11200	A
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	9200	A
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	9800	A
J <sup>2</sup> dt	T <sub>VJ</sub> = 45°C V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	551000	A <sup>2</sup> s
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	527000	A <sup>2</sup> s
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	423 000	A <sup>2</sup> s
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	403 000	A <sup>2</sup> s
T <sub>VJ</sub>		-40...+150	°C	
T <sub>VJM</sub>		150	°C	
T <sub>stg</sub>		-40...+125	°C	
V <sub>ISOL</sub>	50/60 Hz, RMS I <sub>ISOL</sub> ≤ 1 mA	t = 1 min t = 1 s	3000 3600	V~
M <sub>d</sub>	Mounting torque (M6) Terminal connection torque (M8)	4.5-7/40-62 Nm/lb.in. 11-13/97-115 Nm/lb.in.		
Weight	Typical including screws	750	g	

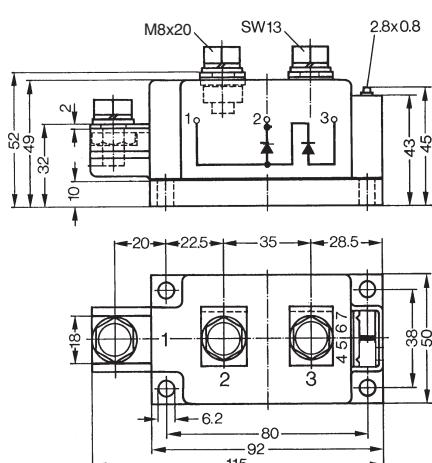
Symbol	Conditions	Characteristic Values		
I <sub>RRM</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> ; V <sub>R</sub> = V <sub>RRM</sub>	30	mA	
V <sub>F</sub>	I <sub>F</sub> = 600 A; T <sub>VJ</sub> = 25°C	1.32	V	
V <sub>TO</sub>	For power-loss calculations only	0.8	V	
r <sub>T</sub>	T <sub>VJ</sub> = T <sub>VJM</sub>	0.6	mΩ	
R <sub>thJC</sub>	per diode; DC current	0.12	K/W	
	per module	0.06	K/W	
R <sub>thJK</sub>	per diode; DC current	0.16	K/W	
	per module	0.08	K/W	
Q <sub>S</sub>	T <sub>VJ</sub> = 125°C; I <sub>F</sub> = 400 A; -di/dt = 50 A/μs	700	μC	
I <sub>RM</sub>		260	A	
d <sub>S</sub>	Creeping distance on surface	12.7	mm	
d <sub>A</sub>	Creepage distance in air	9.6	mm	
a	Maximum allowable acceleration	50	m/s <sup>2</sup>	

Data according to IEC 60747 and refer to a single diode unless otherwise stated.

IXYS reserves the right to change limits, test conditions and dimensions.

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## Dimensions in mm (1 mm = 0.0394")



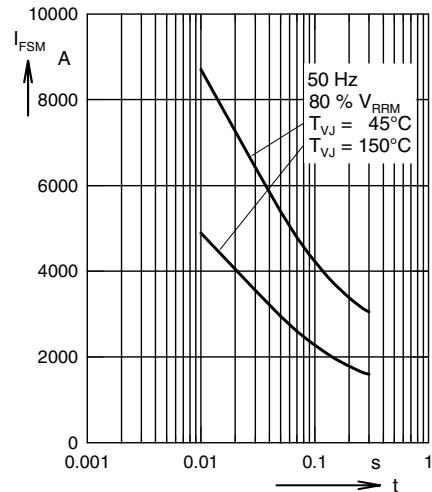


Fig. 1 Surge overload current  
 $I_{FSM}$ : Crest value, t: duration

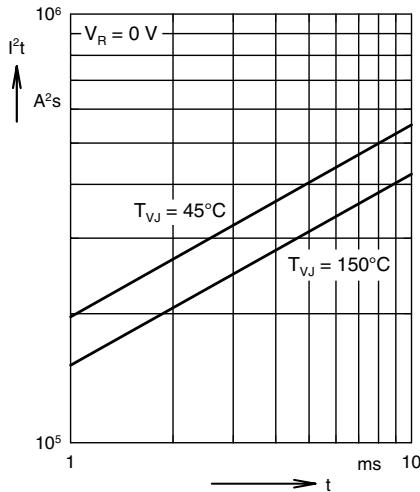


Fig. 2  $I^2t$  versus time (1-10 ms)

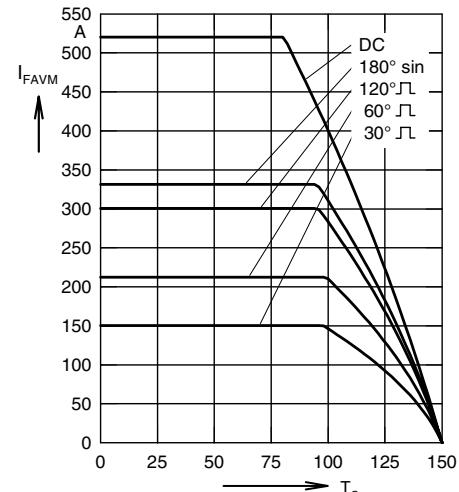


Fig. 3 Maximum forward current  
at case temperature

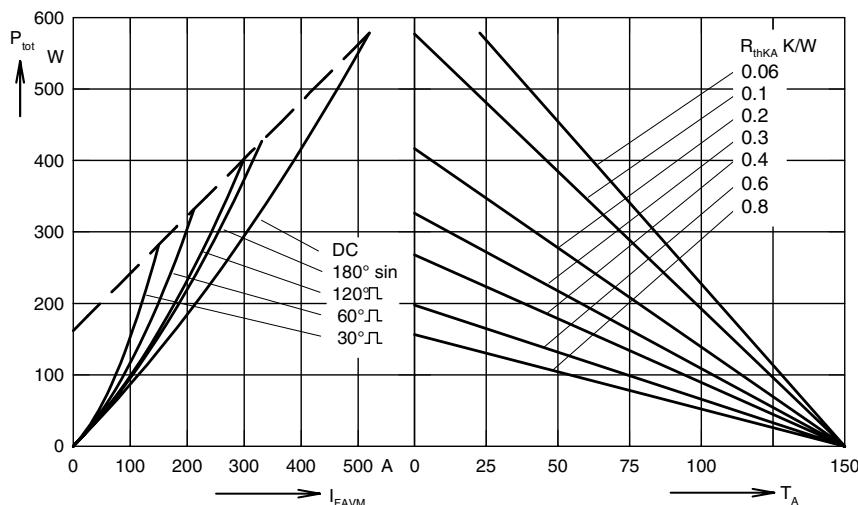


Fig. 4 Power dissipation vs. forward current and ambient temperature (per diode)

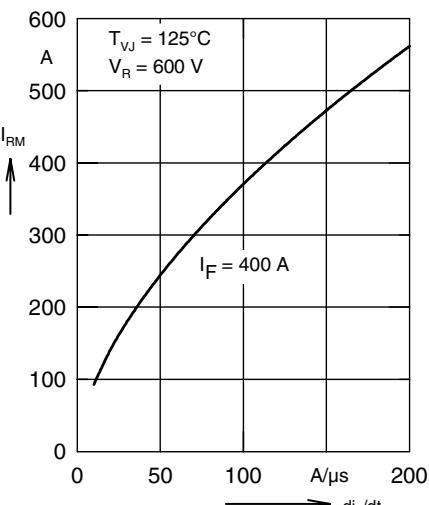


Fig. 5 Typ. peak reverse current  
 $I_{RM}$  versus  $-di_F/dt$

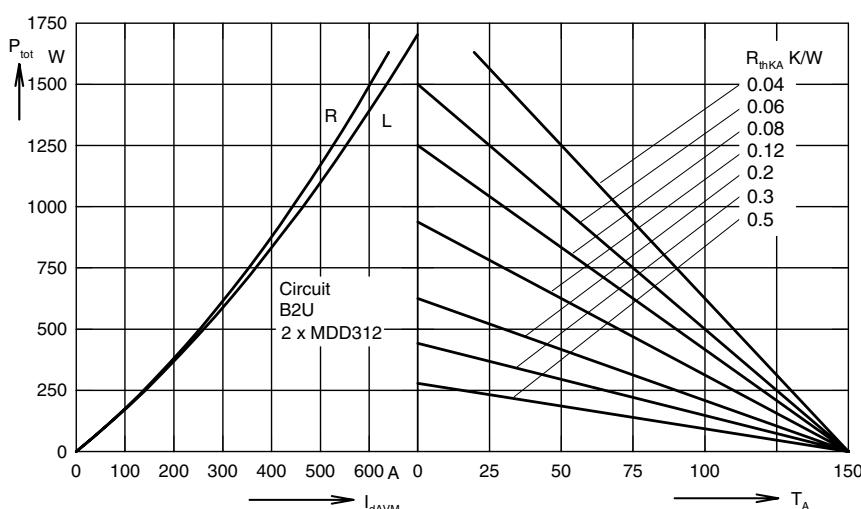


Fig. 6 Single phase rectifier bridge: Power dissipation vs. direct output current and ambient temperature R = resistive load, L = inductive load

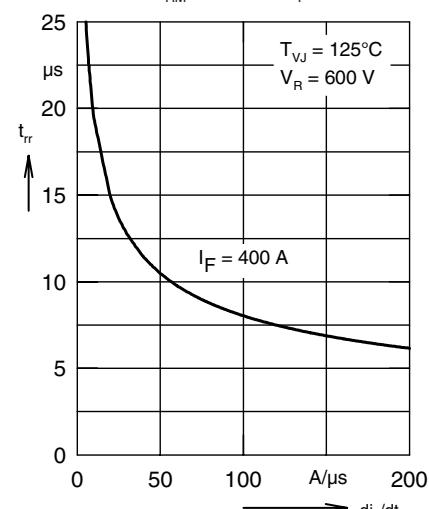


Fig. 7 Typ. recovery time  $t_{rr}$   
versus  $-di_F/dt$

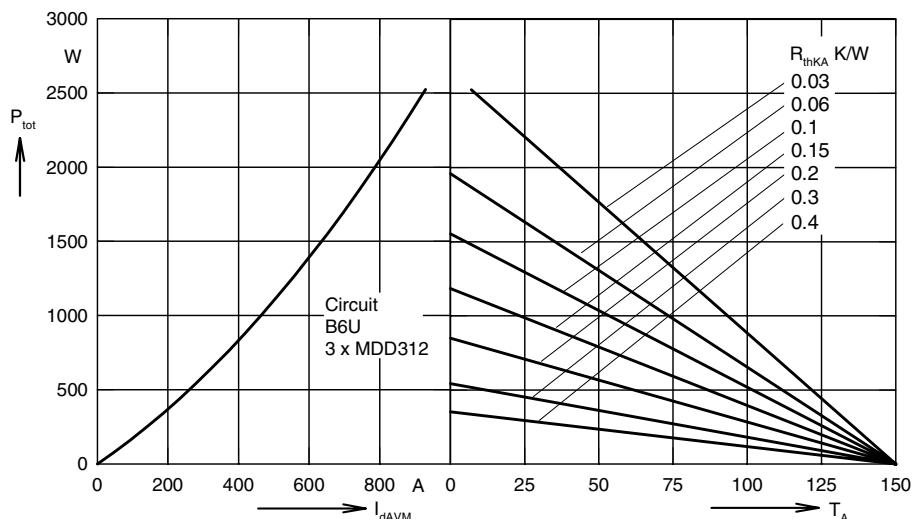


Fig. 8 Three phase rectifier bridge: Power dissipation versus direct output current and ambient temperature

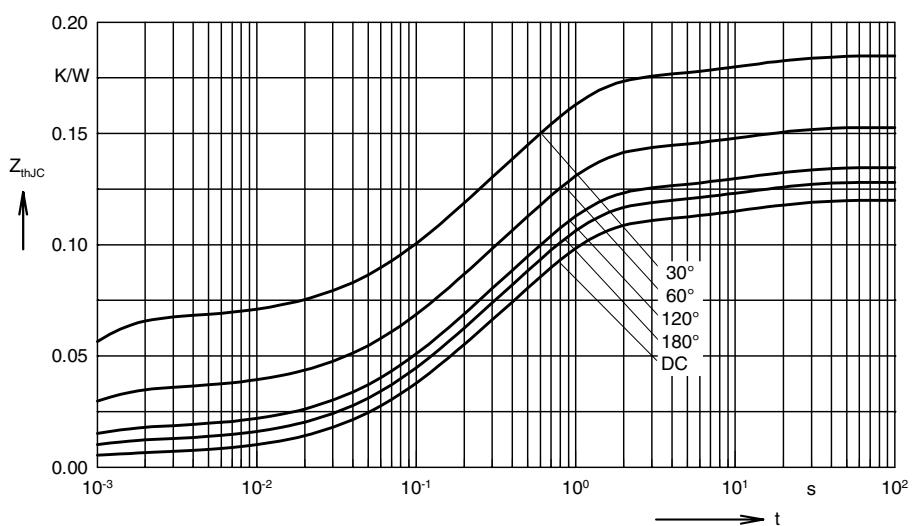


Fig. 9 Transient thermal impedance junction to case (per diode)

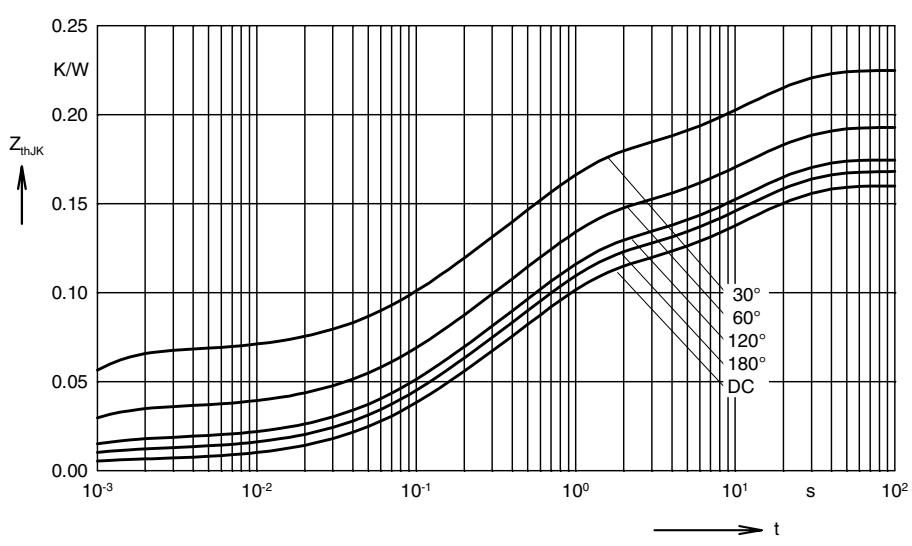


Fig. 10 Transient thermal impedance junction to heatsink (per diode)